



Pin Description

Pin #	Pin Name	Type	Pin Description
1	MOS1_D	MOSFET	Drain of MOSFET1
2	MOS1_D	MOSFET	Drain of MOSFET1 (fused with pin 1)
3	ON_MOS1	Input	Turns on MOS1 (4 M Ω pull down resistor)
4	VDD	VDD	+5VDD Power
5	ON_MOS2	Input	Turns on MOS2 (4 M Ω pull down resistor)
6	MOS2_D	MOSFET	Drain of MOSFET2
7	MOS2_D	MOSFET	Drain of MOSFET2 (fused with pin 6)
8	MOS2_S	MOSFET	Source of MOSFET2 (fused with pin 9)
9	MOS2_S	MOSFET	Source of MOSFET2
10	CAP_MOS2	Input	Sets ramp and turn on time for MOSFET2
11	GND	GND	Ground
12	CAP_MOS1	Input	Sets ramp and turn on time for MOSFET1
13	MOS1_S	MOSFET	Source of MOSFET1 (fused with pin 14)
14	MOS1_S	MOSFET	Source of MOSFET1

Ordering Information

Part Number	Type	Production Flow
SLG59M1526V	STDFN 14L	Industrial, -40 °C to 85 °C
SLG59M1526VTR	STDFN 14L (Tape and Reel)	Industrial, -40 °C to 85 °C



Absolute Maximum Ratings

Parameter	Description	Conditions	Min.	Typ.	Max.	Unit
V_D	Power Supply		--	--	6	V
T_S	Storage Temperature		-65	--	150	°C
ESD_{HBM}	ESD Protection	Human Body Model	2000	--	--	V
W_{DIS}	Package Power Dissipation		--	--	1.2	W
IDS_{MAX}	Max Operating Current				4.5	A
MOSFET IDS_{PK}	Peak Current from Drain to Source	For no more than 10 continuous seconds out of every 100 seconds	--	--	6	A

Note: Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Electrical Characteristics

$T_A = -40\text{ °C}$ to 85 °C (unless otherwise stated)

Parameter	Description	Conditions	Min.	Typ.	Max.	Unit
V_{DD}	Power Supply Voltage		2.5	--	5.5	V
I_{DD}	Power Supply Current when OFF		--	0.1	1	μA
	Power Supply Current ON_MOS_1 & ON_MOS_2 (Steady State)		--	50	75	μA
$R_{DS_{ON}}$	ON Resistance	$T_A\ 25\text{ °C}$ MOSFET1 @100 mA	--	14.5	18	mΩ
		$T_A\ 70\text{ °C}$ MOSFET1 @100 mA	--	17	22	mΩ
		$T_A\ 85\text{ °C}$ MOSFET1 @100 mA		18	23	mΩ
		$T_A\ 25\text{ °C}$ MOSFET2 @100 mA	--	14.5	18	mΩ
		$T_A\ 70\text{ °C}$ MOSFET2 @100 mA	--	17	22	mΩ
		$T_A\ 85\text{ °C}$ MOSFET2 @100 mA		18	23	mΩ
MOSFET IDS	Current from Drain to Source for each MOSFET	Continuous	--	--	4.5	A
V_D	Drain Voltage		0.9	--	V_{DD}	V
T_{ON_Delay}	ON pin Delay Time	50% ON to Ramp Begin	0	300	500	μs
T_{Total_ON}	Total Turn On Time	50% ON to 90% V_S	Configurable ¹			ms
		Example: CAP = 4 nF, $V_{DD} = V_D = 5\text{ V}$, Source_Cap = 10 μF, $R_L = 20\ \Omega$	--	2.0	--	ms
$T_{SLEWRATE}$	Slew Rate	10% V_S to 90% V_S	Configurable ¹			V/ms
		Example: CAP = 4 nF, $V_{DD} = V_D = 5\text{ V}$, Source_Cap = 10 μF, $R_L = 20\ \Omega$	--	3.0	--	V/ms
CAP_{SOURCE}	Source Cap	Source to GND	--	--	1000	μF
R_{DIS}	Discharge Resistance		100	150	300	Ω
ON_ V_{IH}	High Input Voltage on ON pin		0.85	--	V_{DD}	V
ON_ V_{IL}	Low Input Voltage on ON pin		-0.3	0	0.3	V
I_{LIMIT}	Active Current Limit	MOSFET will automatically limit current when $V_S > 250\text{ mV}$	--	6.0	--	A
	Short Circuit Current Limit	MOSFET will automatically limit current when $V_S < 250\text{ mV}$	--	0.5	--	A
$THERM_{ON}$	Thermal shutoff turn-on temperature		--	125	--	°C
$THERM_{OFF}$	Thermal shutoff turn-off temperature		--	100	--	°C



$T_A = -40\text{ }^{\circ}\text{C}$ to $85\text{ }^{\circ}\text{C}$ (unless otherwise stated)

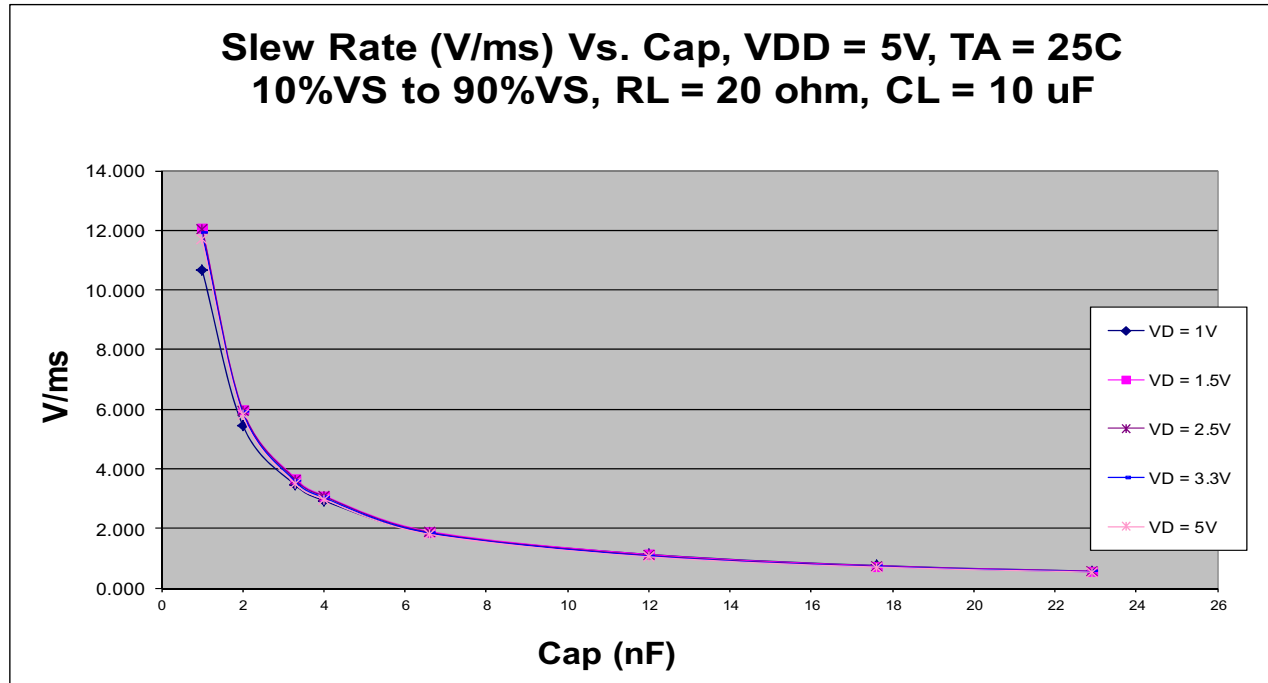
Parameter	Description	Conditions	Min.	Typ.	Max.	Unit
THERM _{TIME}	Thermal shutoff time		--	--	1	ms
T _{OFF_Delay}	OFF Delay Time	50% ON to V _S Fall, V _{DD} = V _D = 5 V	--	--	15	μs

Notes:

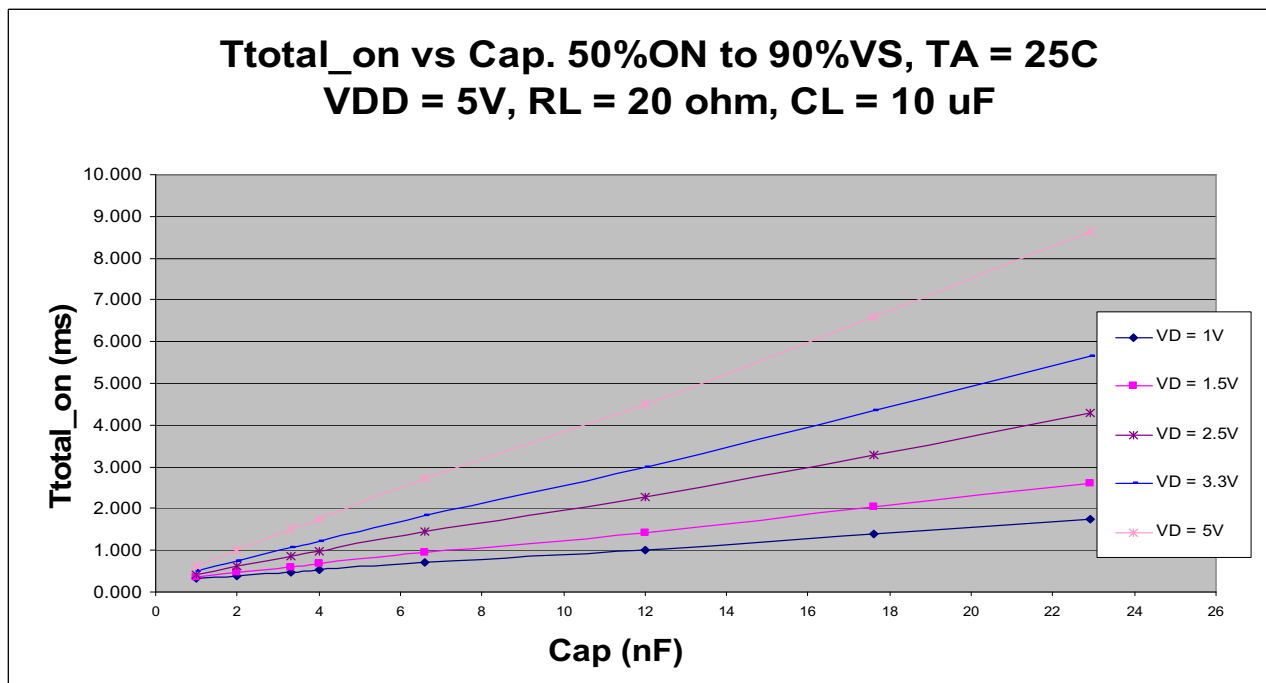
1. Refer to table for configuration details.



T_{SLEW} vs. CAP

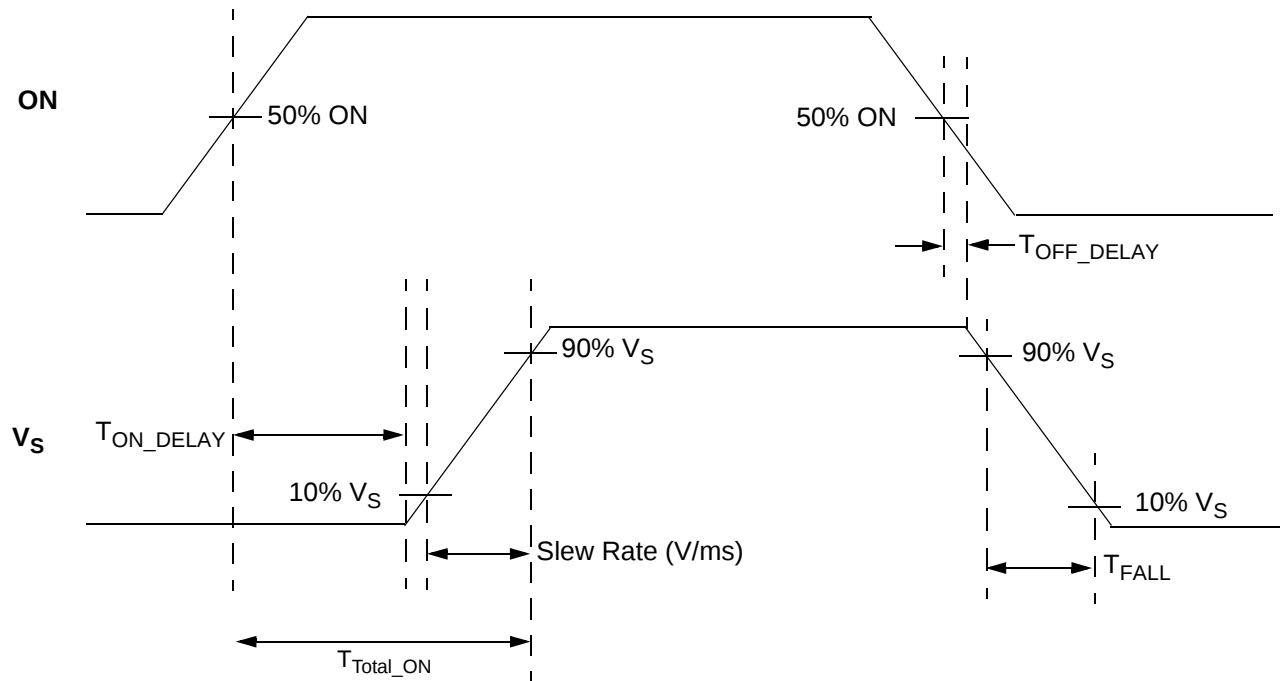


T_{TOTAL_ON} vs. CAP





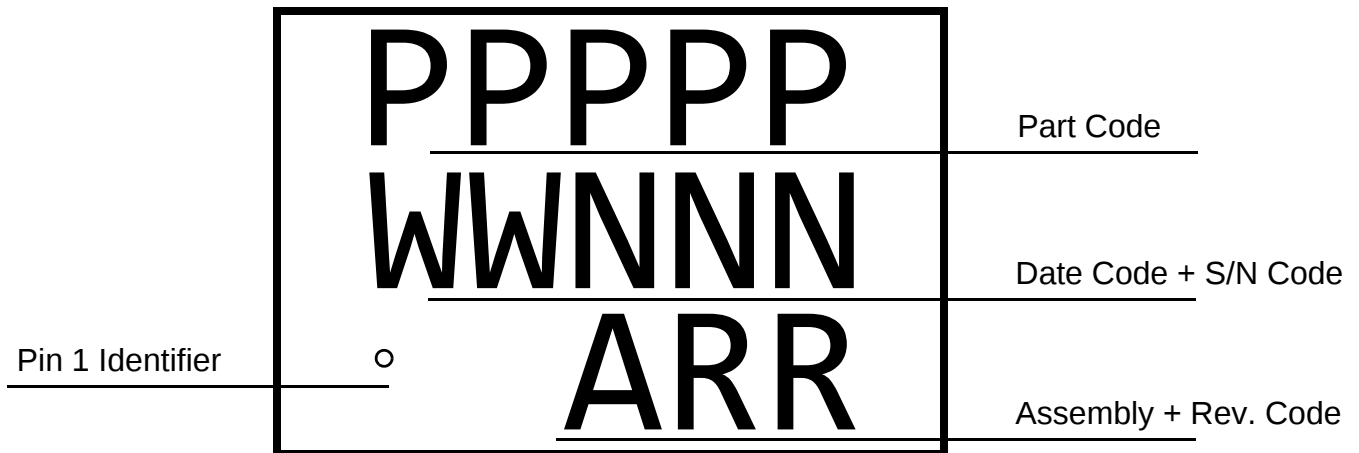
T_{Total_ON} , T_{ON_Delay} and Slew Rate Measurement



More vias for thermal dissipation is better.



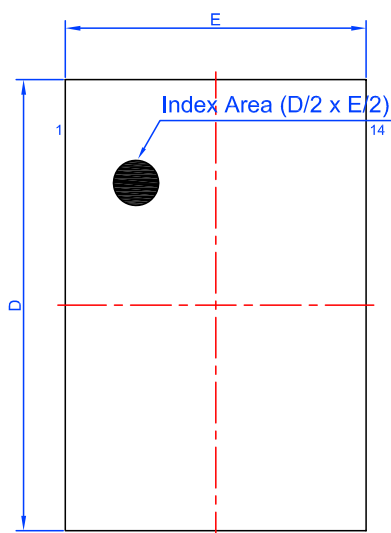
Package Top Marking System Definition



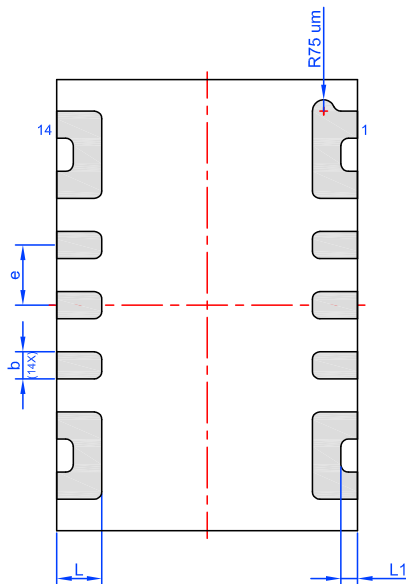


Package Drawing and Dimensions

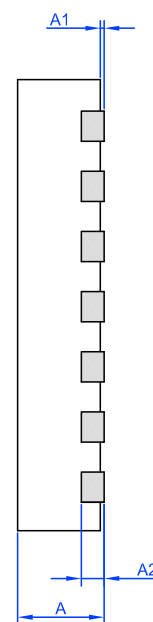
14 Lead STDFN Package 2 mm x 3 mm (Fused Lead)



Top View



BTM View



SIDE View

Unit: mm

Symbol	Min	Nom.	Max	Symbol	Min	Nom.	Max
A	0.50	0.55	0.60	D	2.95	3.00	3.05
A1	0.005	-	0.050	E	1.95	2.00	2.05
A2	0.10	0.15	0.20	L	0.25	0.30	0.35
b	0.13	0.18	0.23	L1	0.06	0.11	0.16
e	0.40 BSC						

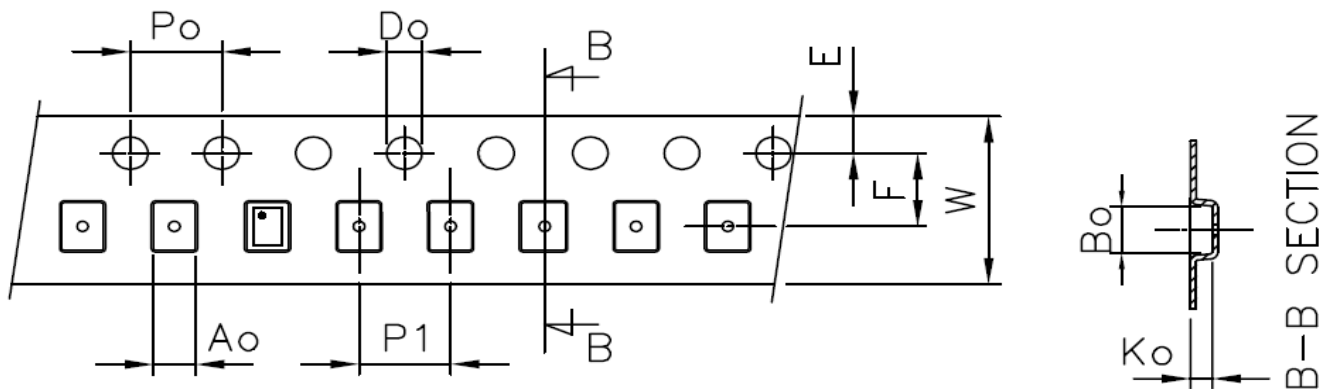


Tape and Reel Specifications

Package Type	# of Pins	Nominal Package Size	Units per Reel	Max Units per Box	Reel & Hub Size (mm)	Trailer A		Leader B		Pocket Tape (mm)	
						Pockets	Length (mm)	Pockets	Length (mm)	Width	Pitch
STDFN 14L 2x3 mm 0.4P FC Green	14	2x3x0.55mm	3000	3000	178/60	100	400	100	400	8	4

Carrier Tape Drawing and Dimensions

Package Type	Pocket BTM Length [mm]	Pocket BTM Width [mm]	Pocket Depth [mm]	Index Hole Pitch [mm]	Pocket Pitch [mm]	Index Hole Diameter [mm]	Index Hole to Tape Edge [mm]	Index Hole to Pocket Center [mm]	Tape Width [mm]
	A0	B0	K0	P0	P1	D0	E	F	W
STDFN 14L 2x3 mm 0.4P FC Green	2.2	3.15	0.76	4	4	1.5	1.75	3.5	8



Recommended Reflow Soldering Profile

Please see IPC/JEDEC J-STD-020: latest revision for reflow profile based on package volume of 3.3 mm³ (nominal). More information can be found at www.jedec.org.



Revision History

Date	Version	Change
10/8/14	1.02	Updated VD Min from 1.0 V to 0.9 V
7/15/14	1.01	Fixed Part Marking Diagram
4/21/14	1.0	Production Release